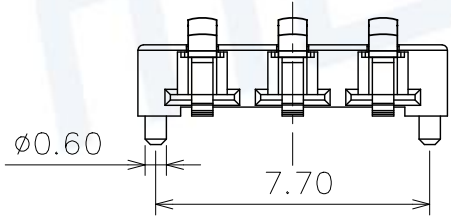
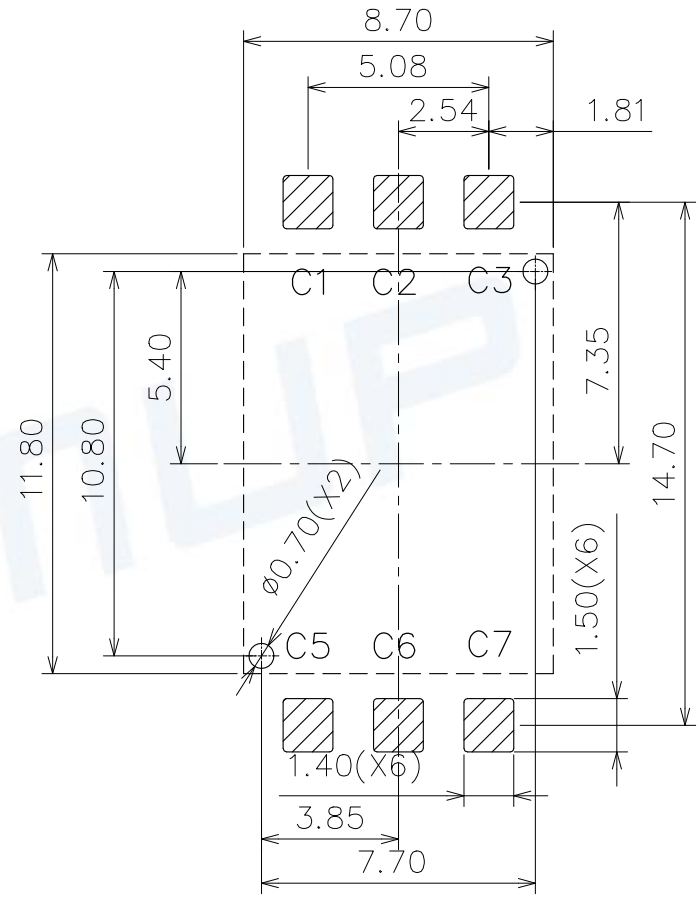
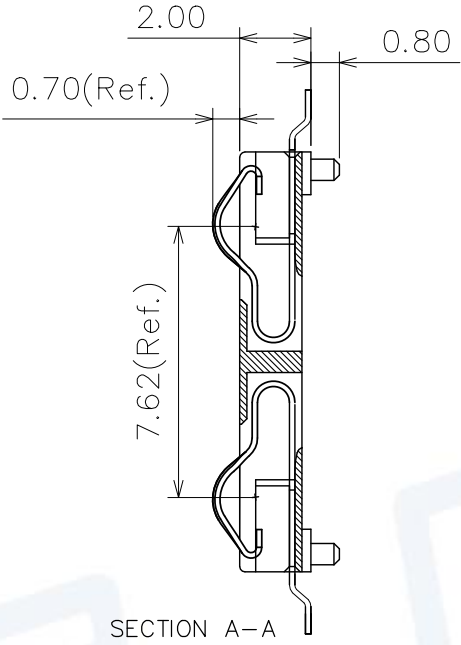
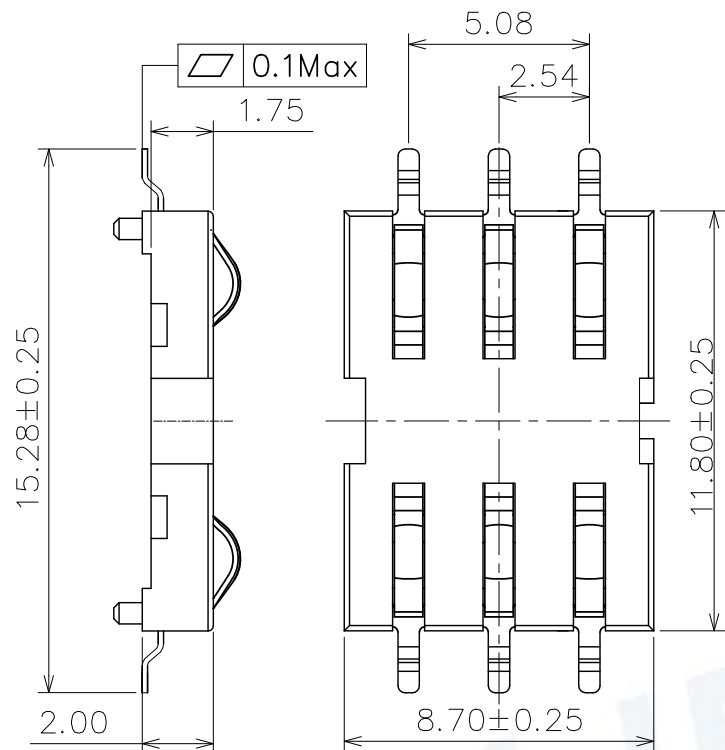


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 11.80LX8.70WX2.0 mm
 Weight: Approx0.33±0.05g
 Durability: 10,000 cycles min.

2.Electrical Characteristics

Contact resistance: 50mΩ typical, 100mΩ max
 Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vaporphase: 215°C, 30sec.Max
 IR reflow: 250°C, 5sec.Max
 Manual soldering: 370°C, 3sec.Max

4.Environmental Characteristics

Operating temperature: -40°C~+85°C
 Operating humidity: 10%~+95%RH

**RECOMMENDED P.C.B LAYOUT
 COMPONENT SIDE(TOLERANCE ±0.05)**

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated

Unless otherwise specified, other tolerance are:

MUP MUP INDUSTRIAL CO.,LTD.

NAME: **Smart Card Acceptor**

MODEL NO: **MUP C725-1**

TYPE: **H2.0 with post&without logo 6p**

PROJ.	UNIT	SCALE	DRAWN	DWG NO.:
①	mm	1:1	Zoey Dec.07.2009	DWG-MUP-C725-001
			CHECKED	SHEET
			Sean Dec.07.2009	1/1
			APPROVAL	REVISION
			Jun Dec.07.2009	X1

